300 to 930MHz Receiver

Evaluation Board Description

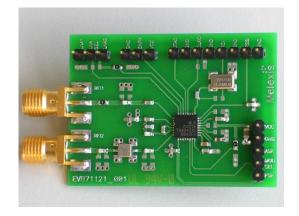


Features

- Dual RF input for antenna space and frequency diversity, LNA cascading or differential feeding
- Fully integrated PLL-based synthesizer
- 2nd mixer with image rejection
- Reception of ASK or FSK modulated signals
- Wide operating voltage and temperature ranges
- Very low standby current consumption
- Low operating current consumption
- Internal IF filter
- Internal FSK demodulator
- Average or peak detection data slicer
- RSSI output with high dynamic range for RF level indication
- Output noise cancellation filter
- MCU clock output
- High over-all frequency accuracy

Application Examples

- General digital and analog RF receivers at 300 to 930MHz
- Tire pressure monitoring systems (TPMS)
- Remote keyless entry (RKE)
- Low power telemetry systems
- Alarm and security systems
- Active RFID tags
- Remote controls
- Garage door openers
- Home and building automation



Ordering information

Part No. (see also sec. 4)

EVB71121-315-C

EVB71121-433-C

EVB71121-868-C EVB71121-915-C

Note 1: Peak detection mode is default population.

General Description

The MLX71121 is a multi-band, single-channel RF receiver based on a double-conversion superheterodyne architecture. It can receive FSK and ASK modulated signals. The IC is designed for general purpose applications for example in the European bands at 433MHz and 868MHz or for similar applications in North America or Asia, e.g. at 315MHz or 915MHz.

300 to 930MHz Receiver Evaluation Board Description



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1. Theory of Operation



1.1. General

The MLX71121 receiver architecture is based on a double-conversion super-heterodyne approach. The two LO signals are derived from an on-chip integer-N PLL frequency synthesizer. The PLL reference frequency is derived from a crystal (XTAL). As the first intermediate frequency (IF1) is very high, a reasonably high degree of image rejection is provided even without using an RF front-end filter. At applications asking for very high image rejections, cost-efficient RF front-end filtering can be realized by using a SAW filter in front of the LNA. The second mixer MIX2 is an image-reject mixer.

The receiver signal chain is setup by one (or two) low noise amplifier(s) (LNA1, LNA2), two down-conversion mixers (MIX1, MIX2), an on-chip IF filter (IFF) as well as an IF amplifier (IFA). By choosing the required modulation via an FSK/ASK switch (at pin MODSEL), either the on-chip FSK demodulator (FSK DEMOD) or the RSSI-based ASK detector is selected. A second order data filter (OA1) and a data slicer (OA2) follow the demodulator. The data slicer threshold can be generated from the mean-value of the data stream or by means of the positive and negative peak detectors (PKDET+/-). A digital post-processing of the sliced data signal can be performed by a noise filter (NF) building block.

The dual LNA configuration can be used for antenna space diversity or antenna frequency diversity or to setup an LNA cascade (to further improve the input sensitivity). The two LNAs can also be setup to feed the RF signal differentially.

A sequencer circuit (SEQ) controls the timing during start-up. This is to reduce start-up time and to minimize power dissipation.

A clock output, which is a divide-by-8 version of the crystal oscillator signal, can be used to drive a microcontroller. The clock output is open collector and gets activated through a load connected to positive supply.

1.2. Technical Data Overview

Input frequency ranges: 300 to 470MHz

610 to 930MHz

Power supply range: 2.1 to 5.5V

Temperature range: -40 to +125°C

Shutdown current: 50 nA

Operating current: 10.0 to 11.1mA

Internal IF: 1.8MHz with 300kHz 3dB bandwidth

 FM/FSK deviation range: ±10kHz to ±100kHz Image rejection:
 65dB 1st IF (with external RF front-end filter)
 25dB 2nd IF (internal image rejection)

Maximum data rate:

50kps RZ (bi-phase) code,

100kps NRZ

Spurious emission: < -54dBm</p>

Linear RSSI range: > 60dB

Crystal reference frequency: 16 to 27MHz

MCU clock frequency: 2.0 to 3.4MHz

☐ Input Sensitivity: at 4kbps NRZ, BER = 3·10 ⁻³						
	Frequency	315 MHz	433.92 MHz	868.3 MHz	915 MHz	
FSK	internal IF2=1.8MHz, 300kHz BW, $\Delta f = \pm 20$ kHz	-107dBm	-107dBm	-104dBm	-102dBm	
ASK	internal IF2=1.8MHz, 300kHz BW	-112dBm	-112dBm	-108dBm	-105dBm	

Note: - Sensitivities given for RF input 1 (without SAW filter)

- Sensitivity for RF input 2 is about 2 to 3dB worse (because of SAW filter loss)



1.3. Block Diagram

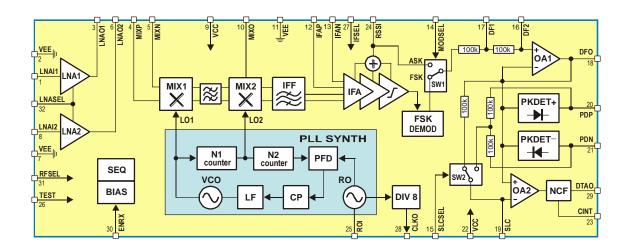


Fig. 1: MLX71121 block diagram

The MLX71121 receiver IC consists of the following building blocks:

- PLL synthesizer (PLL SYNTH) to generate the first and second local oscillator signals LO1 and LO2.
 - The PLL SYNTH consists of a fully integrated voltage-controlled oscillator (VCO), a distributed feedback divider chain (N1, N2), a phase-frequency detector (PFD) a charge pump (CP), a loop filter (LF) and a crystal-based reference oscillator (RO).
- Two low-noise amplifiers (LNA) for high-sensitivity RF signal reception
- First mixer (MIX1) for down-conversion of the RF signal to the first IF (intermediate frequency)
- Second mixer (MIX2) with image rejection for down-conversion from the first to the second IF
- IF Filter (IFF) with a 1.8MHz center frequency and a 300kHz 3dB bandwidth
- IF amplifier (IFA) to provide a high voltage gain and an RSSI signal output
- FSK demodulator (FSK DEMOD)
- Operational amplifiers OA1 and OA2 for low-pass filtering and data slicing, respectively
- Positive (PKDET+) and negative (PKDET-) peak detectors
- Switches SW1 to select between FSK and ASK as well as SW2 to chose between averaging or peak detection mode.
- Noise cancellation filter (NCF)
- Sequencer circuit (SEQ) and biasing (BIAS) circuit
- Clock output (DIV8)



1.4. Operating Modes

ENRX	Description	
0	Shutdown mode	
1	Receive mode	

Note: ENRX is pulled down internally.

1.5. Frequency Range

Two different receive frequency ranges can be selected by the control signal RFSEL.

RFSEL	Description	
0	Input frequency range 300 to 470MHz	
1	Input frequency range 610 to 930MHz	

1.6. LNA Selection

LNASEL	Description			
0	LNA1 active, LNA2 shutdown			
Hi-Z	LNA1 and LNA2 active			
1	LNA1 shutdown, LNA2 active			

Note: Hi-Z state means pin LNASEL is left floating (pin is internally pulled to $V_{\text{CC}}/2$ in this case).

1.7. Demodulation Selection

MODSEL	Description	
0	ASK demodulation	
1	FSK demodulation	

1.8. Data Slicer

SLCSEL	Description	
0	Averaging detection mode	
1	Peak detection mode	



2. Frequency Planning

Because of the double conversion architecture that employs two mixers and two IF signals, there are four different combinations for injecting the LO1 and LO2 signals:

LO1 high side and LO2 high side: receiving at f_{RF}(high-high)
 LO1 high side and LO2 low side: receiving at f_{RF}(high-low)
 LO1 low side and LO2 high side: receiving at f_{RF}(low-high)
 LO1 low side and LO2 low side: receiving at f_{RF}(low-low)

As a result, four different radio frequencies (RFs) could yield one and the same second IF (IF2). Fig. 2 shows this for the case of receiving at f_{RF} (high-high). In the example of Fig. 2, the image signals at f_{RF} (low-high) and f_{RF} (low-low) are suppressed by the bandpass characteristic provided by the RF front-end. The bandpass shape can be achieved either with a SAW filter (featuring just a couple of MHz bandwidth), or by the tank circuits at the LNA input and output (this typically yields 30 to 60MHz bandwidth). In any case, the high value of the first IF (IF1) helps to suppress the image signals at f_{RF} (low-high) and f_{RF} (low-low).

The two remaining signals at IF1 resulting from f_{RF} (high-high) and f_{RF} (high-low) are entering the second mixer MIX2. This mixer features image rejection with so-called single-sideband (SSB) selection. This means either the upper or lower sideband of IF1 can be selected. In the example of Fig. 2, LO2 high-side injection has been chosen to select the IF2 signal resulting from f_{RF} (high-high).

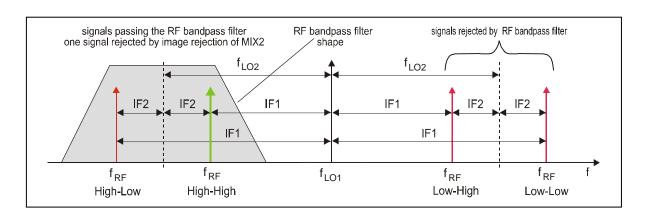


Fig. 2: The four receiving frequencies in a double conversion superhet receiver

It can be seen from the block diagram of Fig. 1 that there is a fixed relationship between the LO signal frequencies (f_{LO1} , f_{LO2}) and the reference oscillator frequency f_{RO} .

$$\mathbf{f}_{\text{LO1}} = \mathbf{N}_{1} \cdot \mathbf{f}_{\text{LO2}} \qquad \qquad \mathbf{f}_{\text{LO2}} = \mathbf{N}_{2} \cdot \mathbf{f}_{\text{RO}}$$

The operating frequency of the internal IF filter (IFF) and FSK demodulator (FSK DEMOD) is 1.8MHz. Therefore the second IF (IF2) is set to 1.8MHz as well.



2.1. Calculation of Frequency Settings

The receiver has two predefined receive frequency plans which can be selected by the RFSEL control pin. Depending on the logic level of RFSEL pin the sideband selection of the second mixer and the counter settings for N_1 and N_2 are changed accordingly. (see in 1.5)

RFSEL	Injection	f _{Rfmin} [MHz]	f _{Rfmax} [MHz]	N ₁	N ₂
0	high-low	300	470	4	6
1	low-high	610	930	2	12

The following table shows the relationships of several internal receiver frequencies for the two input frequency ranges.

f _{RF} [MHz]	f _{IF1}	f _{LO1}	f _{LO2}	f _{RO}
300 to 470	$\frac{f_{RF} + N_1 f_{IF2}}{N_1 - 1}$	$\frac{N_{1}(f_{RF} + f_{IF2})}{N_{1} - 1}$	$\frac{f_{RF}+f_{IF2}}{N_1-1}$	$\frac{f_{RF} + f_{IF2}}{N_2(N_1 - 1)}$
610 to 930	$\frac{\mathbf{f}_{RF} - \mathbf{N}_{1} \mathbf{f}_{1F2}}{\mathbf{N}_{1} + 1}$	$\frac{N_{1}(f_{RF} + f_{IF2})}{N_{1} + 1}$	$\frac{f_{RF}+f_{IF2}}{N_1+1}$	$\frac{f_{RF} + f_{IF2}}{N_2(N_1 + 1)}$

Given IF2 = 1.8MHz and the corresponding N_1 , N_2 counter settings, above equations can be transferred into the following table.

f _{RF} [MHz]	f _{IF1}	f _{LO1}	f _{LO2}	f _{RO}
300 to 470	$\frac{f_{RF} + 7.2MHz}{3}$	$\frac{4(f_{RF} + 1.8M \text{ Hz})}{3}$	$f_{RF} + 1.8MHz$	$\frac{f_{RF} + 1.8MHz}{18}$
610 to 930	$\frac{f_{RF} - 3.6MHz}{3}$	$\frac{2(f_{RF} + 1.8MHz)}{3}$	3	$\frac{f_{RF} + 1.8MHz}{36}$



2.2. Standard Frequency Plans

IF2 = 1.8MHz.

RFSEL	f _{RF} [MHz]	f _{IF1} [MHz]	f _{LO1} [MHz]	f _{LO2} [MHz]	f _{RO} [MHz]
0	315	107.40	422.40	105.60	17.600000
0	433.92	147.04	580.96	145.24	24.206667
1	868.3	288.23	580.07	290.03	24.169444
1	915	303.80	611.20	305.60	25.466667

2.3. 433/868MHz Frequency Diversity

The receiver's multi-band functionality can be used to operate at two different frequency bands just by changing the logic level at pin RFSEL and without changing the crystal. This feature is applicable for common use of the 433 and 868MHz bands. Below table shows the corresponding frequency plans.

IF2 = 1.8MHz.

RFSEL	f _{RF} [MHz]	f _{IF1} [MHz]	f _{LO1} [MHz]	f _{LO2} [MHz]	f _{RO} [MHz]
0	433.25	146.82	580.07	145.02	24.169444
1	868.3	288.23	580.07	290.03	24.169444



3. Dual-Channel Application Circuits for FSK & ASK Reception

3.1. Peak Detector Data Slicer

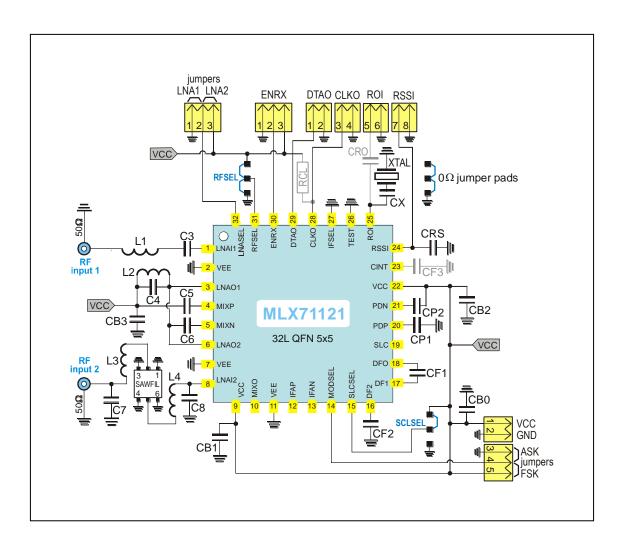


Fig. 3: Circuit schematic



3.1.1. Component Arrangement Top Side (Peak Detection Data Slicer)

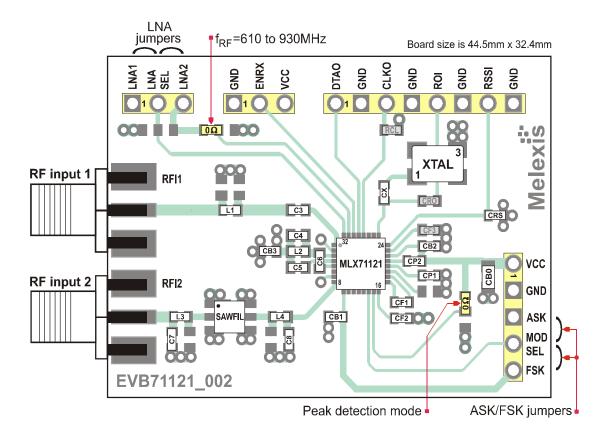


Fig. 4: PCB top-side view



3.2. Averaging Data Slicer Configured for Bi-Phase Codes

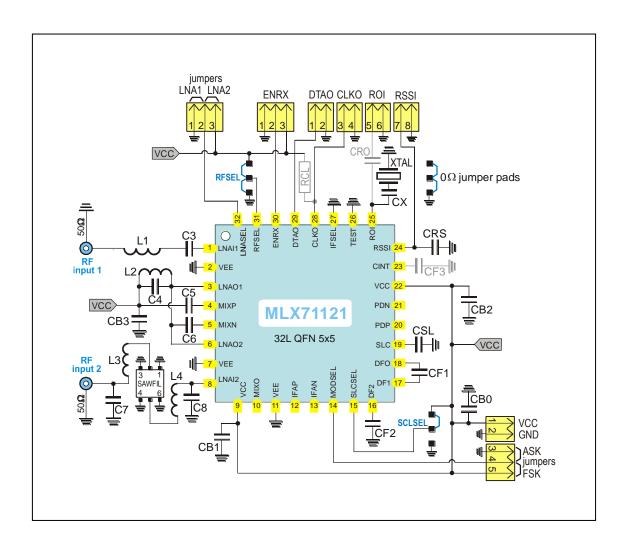


Fig. 5: Circuit schematic



3.2.1. Component Arrangement Top Side (Averaging Data Slicer)

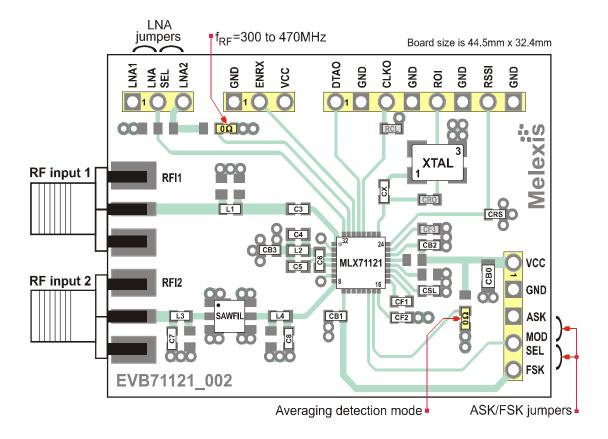


Fig. 6: PCB top-side view



3.3. Component List for Antenna Space Diversity

Below table is for all application circuits shown in Figures 3.1 and 3.2

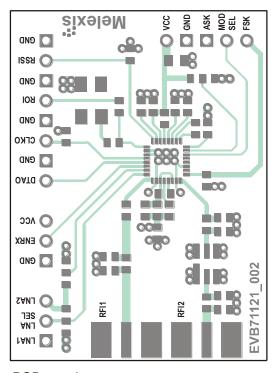
Part Size Value @ 315 MHz 33.92 MHz 866.3 MHz 915 MHz 915 MHz	Delow to	15.0		in circuits snow	_					
C4	Part	Size			Value @ 868.3 MHz		Tol.	Description		
C5	C3	0603	100 pF	100 pF	100 pF 100 pF		±5%	LNA input filtering capacitor		
C6	C4	0603	4.7 pF	3.9 pF	2.2 pF	1.5 pF	±5%	LNA output tank capacitor		
C7 0603 NIP	C5	0603	100 pF	100 pF	100 pF	100 pF	±5%	MIX1 positive input matching capacitor		
C8	C6	0603	100 pF	100 pF	100 pF	100 pF	±5%	MIX1 negative input matching capacitor		
C80	C7	0603	NIP	4.7 pF	3.9 pF	NIP	±5%	matching capacitor		
CB1 0603 330 pF 330 pF 330 pF 330 pF 110% decoupling capacitor, decoupling capacitor, decoupling capacitor, CB2 0603 330 pF 330 pF 330 pF 110% decoupling capacitor, decoupling capacitor, CF1 0603 680 pF 680 pF 680 pF 680 pF 480 pF	C8	0603	NIP	NIP	1.0 pF	NIP	±5%	matching capacitor		
CB2 0603 330 pF 330 pF 330 pF 330 pF 330 pF 410% decoupling capacitor, data low-pass filter capacitor, for data rate of 4 kbps NRZ CF2 0603 330 pF 330 pF 330 pF 330 pF 410% data low-pass filter capacitor, for data rate of 4 kbps NRZ CF2 0603 330 pF 330 pF 330 pF 330 pF 410% data low-pass filter capacitor, for data rate of 4 kbps NRZ CF3 0603 value according to the date rate ±10% optional capacitor, for data rate of 4 kbps NRZ CP1 0603 33 nF 33 nF 33 nF 33 nF +10% optional capacitor, for data rate of 4 kbps NRZ CP2 0603 1 nF 1 nF <t< td=""><td>CB0</td><td>0805</td><td>330 nF</td><td>330 nF</td><td>330 nF</td><td>330 nF</td><td>±10%</td><td>decoupling capacitor,</td></t<>	CB0	0805	330 nF	330 nF	330 nF	330 nF	±10%	decoupling capacitor,		
CB3 0603 330 pF 330 pF 330 pF 330 pF 330 pF 410% decoupling capacitor, data low-pass filter capacitor, for data rate of 4 kbps NRZ CF1 0603 680 pF 680 pF 680 pF 680 pF ±10% for data rate of 4 kbps NRZ CF2 0603 330 pF 330 pF 330 pF ±10% for data rate of 4 kbps NRZ CF3 0603 connected to ground if noise filter not used ±10% for data rate of 4 kbps NRZ CP1 0603 33 nF 33 nF 33 nF 33 nF PKDET positive filtering capacitor, for data rate of 4 kbps NRZ CP2 0603 33 nF 33 nF 33 nF 410% for data rate of 4 kbps NRZ CRS 0603 1 nF 1 nF 1 nF 1 nF 2 nF 2 pKDET negative filtering capacitor, for data rate of 4 kbps NRZ CRS 0603 1 nF 1 nF 1 nF 1 nF 2 nF 2 nF 2 nF 2 nF 2 nF 2 nF RSSI output low pass capacitor optional capacitor, for data rate of 4 kbps NRZ CRS 0603 1 nF 1 nF 1 nF	CB1	0603	330 pF	330 pF	330 pF	330 pF	±10%	decoupling capacitor,		
CF1 0603 680 pF 680 pF 680 pF 680 pF 580 pF	CB2	0603	330 pF	330 pF	330 pF	330 pF	±10%	decoupling capacitor,		
CF1 0603 680 pF 680 pF 680 pF 680 pF 680 pF 580 pF	CB3	0603	330 pF	330 pF	330 pF	330 pF	±10%	decoupling capacitor,		
CF2	CF1	0603	680 pF	680 pF	680 pF	680 pF	±10%			
CP1 0603	CF2	0603	330 pF	330 pF	330 pF	330 pF	±10%			
CP1	CES	0603		value according t	o the date rate	±100/	entional canacitance for noise filter			
CP2 0603 33 nF 33 nF 33 nF 33 nF 33 nF 10603 33 nF 35 nF 33	CF3	0603	cor	nected to ground it	f noise filter not u	sed	±10%	optional capacitance for noise filter		
CRS 0603 1 nF 1 nF 1 nF 1 nF ±10% for data rate of 4 kbps NRZ CRO 0603 1 nF 1 nF 1 nF 1 nF ±5% optional capacitor CRO 0603 1 nF 1 nF 1 nF 1 nF ±5% optional capacitor, to couple external RO signal CSL 0603 100 nF 100 nF 100 nF 100 nF 100 nF CX 0603 27 pF 27 pF 27 pF 27 pF ±5% crystal series capacitor L1 0603 56 nH 27 nH 0Ω 0Ω ±5% matching inductor L2 0603 27 nH 15 nH 3.9 nH 3.9 nH ±5% LNA output tank inductor L3 0603 0Ω 47 nH 22 nH 0Ω ±5% matching inductor L4 0603 56 nH 68 nH 22 nH 0Ω ±5% matching inductor RCL 0603 3.3 kΩ 3.3 kΩ 3.3 kΩ 3.3 kΩ 3.3 kΩ 5.5 matching inductor RCL 0603 56 nH 68 nH 22 nH 0Ω ±5% matching inductor RCL 0603 56 nH 68 nH 22 nH 0Ω Ω ±5% matching inductor RCL 0603 56 nH 68 nH 22 n	CP1	0603	33 nF	33 nF	33 nF	33 nF	±10%			
CRO 0603 1 nF 1 nF 1 nF 1 nF ±5% optional capacitor, to couple external RO signal CSL 0603 100 nF 100 nF 100 nF 100 nF ±10% data slicer capacitor, for data rate of 4 kbps NRZ CX 0603 27 pF 27 pF 27 pF 27 pF ±5% crystal series capacitor L1 0603 56 nH 27 nH 0 Ω 0 Ω ±5% matching inductor L2 0603 27 nH 15 nH 3.9 nH 3.9 nH ±5% LNA output tank inductor L3 0603 0 Ω 47 nH 22 nH 0 Ω ±5% matching inductor L4 0603 56 nH 68 nH 22 nH 0 Ω ±5% matching inductor RCL 0603 3.3 kΩ 3.3 kΩ 3.3 kΩ 3.3 kΩ ±5% optional CLK output resistor, to clock output signal generated SAW SMD SAFDC315M SAFCC868M SAFCC915M AL0N00 (915 MHz) low-loss SAW filter from Murata or equivalent part <td>CP2</td> <td>0603</td> <td>33 nF</td> <td>33 nF F</td> <td>33 nF</td> <td>33 nF</td> <td>±10%</td> <td colspan="3">· · ·</td>	CP2	0603	33 nF	33 nF F	33 nF	33 nF	±10%	· · ·		
CRO 0603 1 nF 1 nF 1 nF 1 nF ±5% to couple external RO signal CSL 0603 100 nF 100 nF 100 nF 100 nF ±10% data slicer capacitor, for data rate of 4 kbps NRZ CX 0603 27 pF 27 pF 27 pF ±5% crystal series capacitor L1 0603 56 nH 27 nH 0 Ω 0 Ω ±5% matching inductor L2 0603 27 nH 15 nH 3.9 nH 3.9 nH ±5% LNA output tank inductor L3 0603 0 Ω 47 nH 22 nH 0 Ω ±5% matching inductor L4 0603 56 nH 68 nH 22 nH 0 Ω ±5% matching inductor RCL 0603 3.3 kΩ 3.3 kΩ 3.3 kΩ 3.3 kΩ ±5% matching inductor SAPCC315M SM0700 (315 MHz) SAFCC868M SM0700 (315 MHz) SAFCC868M SM0700 (315 MHz) SAFCC915M AL0N00 (868.3 MHz) Iow-loss SAW filter from Murata or equivalent part XTAL SMD SM0700 (315 MHz)	CRS	0603	1 nF	1 nF	1 nF	1 nF	±10%	RSSI output low pass capacitor		
CSL 0603 for averaging detection mode only ±10% for data rate of 4 kbps NRZ CX 0603 27 pF 27 pF 27 pF ±5% crystal series capacitor L1 0603 56 nH 27 nH 0 Ω 0 Ω ±5% matching inductor L2 0603 27 nH 15 nH 3.9 nH ±5% LNA output tank inductor L3 0603 0 Ω 47 nH 22 nH 0 Ω ±5% matching inductor RCL 0603 56 nH 68 nH 22 nH 0 Ω ±5% matching inductor RCL 0603 3.3 kΩ 3.3 kΩ 3.3 kΩ ±5% optional CLK output resistor, to clock output signal generated SAW SMD SMDO00 (315 MHz) SAFCC868M SAFCC868M ALON00 (915 MHz) low-loss SAW filter from Murata or equivalent part XTAL SMD 5x3.2 17.60000 24.206667 MHZ- 42.406667MHZ- 42.40644MHZ 25.46667MHZ- 12-50-F-H20- T2075-W2-T HEX24- 12-50-F-H20- T2075- W2-T Crystal from Telcona, or equivalent part	CRO	0603	1 nF	1 nF	1 nF	1 nF	±5%			
CX 0603 27 pF 27 pF 27 pF 27 pF 27 pF ±5% crystal series capacitor	CSI	0602	100 nF 100 nF 100 nF 100 nF				±100/	data slicer capacitor,		
L1 0603 56 nH 27 nH 0 Ω 0 Ω ±5% matching inductor L2 0603 27 nH 15 nH 3.9 nH 3.9 nH ±5% LNA output tank inductor L3 0603 0 Ω 47 nH 22 nH 0 Ω ±5% matching inductor L4 0603 56 nH 68 nH 22 nH 0 Ω ±5% matching inductor RCL 0603 3.3 kΩ 3.3 kΩ 3.3 kΩ ±5% matching inductor SAW SAFD 3.3 kΩ 3.3 kΩ ±5% matching inductor SAW SAFD 3.3 kΩ 3.3 kΩ ±5% matching inductor SAFD 3.3 kΩ 3.3 kΩ 3.3 kΩ ±5% optional CLK output resistor, to clock output signal generated SAFD SAFCC915M ALON00 SAFCC915M ALON00 Iow-loss SAW filter from Murata or equivalent part XTAL SMD T7.60000 MHz HEX24- HEX24- 14.169444 HEX24- 16.466667MHz- Crystal from Telcona	CSL	0603		for averaging dete	ction mode only	±10%	for data rate of 4 kbps NRZ			
L2 0603 27 nH 15 nH 3.9 nH ±5% LNA output tank inductor L3 0603 0 Ω 47 nH 22 nH 0 Ω ±5% matching inductor L4 0603 56 nH 68 nH 22 nH 0 Ω ±5% matching inductor RCL 0603 3.3 kΩ 3.3 kΩ 3.3 kΩ ±5% optional CLK output resistor, to clock output signal generated SAW FIL SMD SMOTOO (315 MHz) SAFCC315M SMOTOO (315 MHz) SAFCC868M SL0X0O (868.3 MHz) SAFCC915M AL0NOO (915 MHz) low-loss SAW filter from Murata or equivalent part XTAL SMD	CX	0603	27 pF	27 pF	27 pF	27 pF	±5%	crystal series capacitor		
L3 0603 0 Ω 47 nH 22 nH 0 Ω ±5% matching inductor L4 0603 56 nH 68 nH 22 nH 0 Ω ±5% matching inductor RCL 0603 3.3 kΩ 3.3 kΩ 3.3 kΩ ±5% optional CLK output resistor, to clock output signal generated SAW FIL SMD SMD TOO (315 MHz) RF3446 (433.92 MHz) SAFCC868M SL0X00 (868.3 MHz) SAFCC915M AL0N00 (915 MHz) low-loss SAW filter from Murata or equivalent part XTAL SMD SMD TOO MHz 17.60000 MHz 24.206667 MHz 24.169444 MHz MHz 4.169444 MHz 4.169444 MHz 4.169444 MHz 4.169444 MHz 25.46667 MHz 4.125-0-F-H20-T2075-W2-T Crystal from Telcona, or equivalent part XTAL SMD 5x3.2 T2075-W2-T T2075-W2-T T2075-W2-T HEX24-P20-T2075-W2-T 4.169444 MHz 21.2-50-F-H20-T2075-W2-T Crystal from Telcona, or equivalent part	L1	0603	56 nH	27 nH	0Ω	0Ω	±5%	matching inductor		
L4 0603 56 nH 68 nH 22 nH 0 Ω ±5% matching inductor RCL 0603 3.3 kΩ 3.3 kΩ 3.3 kΩ ±5% optional CLK output resistor, to clock output signal generated SAW FIL SMD SMD SMOT00 (315 MHz) RF3446 (433.92 MHz) SAFCC868M SL0X00 (915 MHz) SAFCC915M AL0N00 (915 MHz) low-loss SAW filter from Murata or equivalent part XTAL SMD SMD SMD SMD SMHz 17.60000 MHz 24.206667 MHz MHz 25.46667 MHz MHz HEX24-24.169444 MHz SMHz HEX24-24.169444 MHz SMHz HEX24-25.466667MH Z-12-50-F-H20-12-50-F-H20-12-50-F-H20-12075-W2-T T2075-W2-T HEX24-12-50-F-H20-12075-W2-T T2075-W2-T T2075-W2-T T2075-W2-T T2075-W2-T T2075-W2-T W2-T T2075-W2-T T2075-W2-T W2-T T2075-W2-T	L2	0603	27 nH	15 nH	3.9 nH	3.9 nH	±5%	LNA output tank inductor		
RCL 0603 3.3 kΩ 3.3 kΩ 3.3 kΩ ±5% optional CLK output resistor, to clock output signal generated SAW FIL SMD SMD TIL SAFDC315M SM0700 (315 MHz) SAFCC868M SL0X00 (915 MHz) SAFCC915M AL0N00 (915 MHz) low-loss SAW filter from Murata or equivalent part T7.60000 MHz 24.206667 MHz MHz 24.169444 MHz MHz MHz HEX24-24.206667 MHz-12-50-F-H20-12-50-F-H20-12-50-F-H20-12-75-W2-T HEX24-12-50-F-H20-12-50-F-H20-12-50-F-H20-12-75-W2-T Crystal from Telcona, or equivalent part	L3	0603	0Ω	47 nH	22 nH	0Ω	±5%	matching inductor		
SAW SAW SMD SAFDC315M SMOTOO (315 MHz) SAFDC315M SL0X00 (868.3 MHz) (915 MHz) SAFDC315M SL0X00 (915 MHz) SAFDC315M SL0X0O (915 MHz) SAFDC315M SAFDC315M SAFDC315M SAFDC315M SAFDC315M SL0X0O (915 MHz) SAFDC315M SA	L4	0603	56 nH	68 nH	22 nH	0Ω	±5%	matching inductor		
SAW FIL SMD 3x3 SMOT00 (315 MHz) (433.92 MHz) SL0X00 (868.3 MHz) AL0N00 (915 MHz) low-loss SAW filter from Murata or equivalent part XTAL T7.60000 MHz 24.206667 MHz 24.169444 MHz 25.46667 MHz HEX24- 24.206667MHZ- 24.206667MHZ- 24.169444MHZ- 24.169444MHZ- 12-50-F-H20- T2075-W2-T HEX24- 24.169444MHZ- 12-50-F-H20- T2075-W2-T Crystal from Telcona, or equivalent part	RCL	0603	3.3 kΩ	3.3 kΩ	3.3 kΩ	3.3 kΩ	±5%	·		
XTAL SMD 5x3.2			SM0T00		SL0X00	ALON00				
XTAL SMD 5x3.2 SMD 5x3.2 SHEX24- 17.6MHZ-12- 24.206667MHZ- 12-50-F-H20- T2075-W2-T W2-T W2-T W2-T W2-T W2-T W2-T W2-T		1				MHz				
±20ppm cal., ±30ppm temp.	XTAL		17.6MHZ-12- 50-F-H20-	24.206667MHZ- 12-50-F-H20-	24.169444MHZ -12-50-F-H20-	25.466667MH Z-12-50-F- H20-T2075-				
				\pm 20ppm cal., \pm	30ppm temp.					

Note: NIP – not in place, may be used optionally

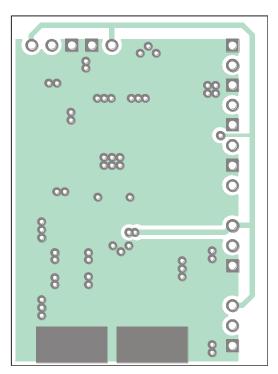
Melexis INSPIRED ENGINEERING

3.4. PCB Layouts for Antenna Space Diversity

Board layout data in Gerber format is available, board size is 32.4mm x 44.5mm.







PCB bottom view

4. Board Versions

Туре	Frequency/MHz		Board Execution		
EVB71121	-315		-A	antenna version	
	-433		-C	connector version	
	-868				
	-915				

Note:

available EVB setups



5. Package Description



The device MLX71121 is RoHS compliant.

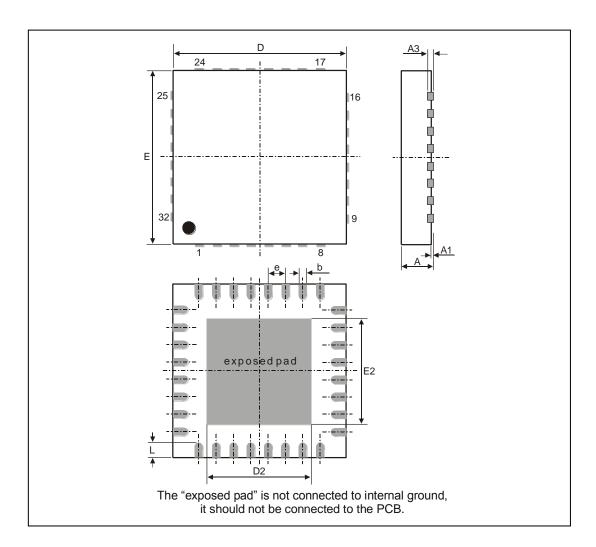


Fig 5: 32L QFN 5x5 Quad

all Dime	all Dimension in mm									
	D	E	D2	E2	Α	A1	А3	L	е	b
min	4.75	4.75	3.00	3.00	0.80	0	0.20	0.3	0.50	0.18
max	5.25	5.25	3.25	3.25	1.00	0.05	0.20	0.5		0.30
all Dime	all Dimension in inch									
min	0.187	0.187	0.118	0.118	0.0315	0	0.0079	0.0118	0.0197	0.0071
max	0.207	0.207	0.128	0.128	0.0393	0.002	0.0079	0.0197		0.0118

5.1. Soldering Information

 The device MLX71121 is qualified for MSL3 with soldering peak temperature 260 deg C according to JEDEC J-STD-20

300 to 930MHz Receiver Evaluation Board Description



6. Reliability Information

This Melexis device is classified and qualified regarding soldering technology, solderability and moisture sensitivity level, as defined in this specification, according to following test methods:

Reflow Soldering SMD's (Surface Mount Devices)

- IPC/JEDEC J-STD-020
 "Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices (classification reflow profiles according to table 5-2)"
- EIA/JEDEC JESD22-A113
 - "Preconditioning of Nonhermetic Surface Mount Devices Prior to Reliability Testing (reflow profiles according to table 2)"

Wave Soldering SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

- EN60749-20
 - "Resistance of plastic- encapsulated SMD's to combined effect of moisture and soldering heat"
- EIA/JEDEC JESD22-B106 and EN60749-15
 - "Resistance to soldering temperature for through-hole mounted devices"

Iron Soldering THD's (Through Hole Devices)

• EN60749-15

"Resistance to soldering temperature for through-hole mounted devices"

Solderability SMD's (Surface Mount Devices) and THD's (Through Hole Devices)

• EIA/JEDEC JESD22-B102 and EN60749-21 "Solderability"

For all soldering technologies deviating from above mentioned standard conditions (regarding peak temperature, temperature gradient, temperature profile etc) additional classification and qualification tests have to be agreed upon with Melexis.

The application of Wave Soldering for SMD's is allowed only after consulting Melexis regarding assurance of adhesive strength between device and board.

Melexis is contributing to global environmental conservation by promoting **lead free** solutions. For more information on qualification of **RoHS** compliant products (RoHS = European directive on the Restriction Of the Use of Certain Hazardous Substances) please visit the quality page on our website:

http://www.melexis.com/quality_leadfree.aspx

7. ESD Precautions

Electronic semiconductor products are sensitive to Electro Static Discharge (ESD).

Always observe Electro Static Discharge control procedures whenever handling semiconductor products.

300 to 930MHz Receiver Evaluation Board Description



8. Contact

For the latest version of this document, go to our website at www.melexis.com.

For additional information, please contact our Direct Sales team and get help for your specific needs:

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